AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

- 1. (currently amended): A hologram transfer foil comprising a multilayer structure comprising, in order from top to bottom, a substrate, a volume hologram layer including a volume hologram in a cured resin layer and comprising a matrix polymer, a photopolymerizable compound and a photo-polymerization initiator, a first heat seal layer formed of a solution coating layer having an aqueous thermoplastic resin dissolved in water and a second heat seal layer which are successively stacked, wherein said substrate is releasable from the remainder of the multilayer structure, and wherein in use, said hologram transfer foil is applied on the second heat seal layer side over an application member, and an adhesion force of the volume hologram layer to the application member is larger than a material fracture force for the volume hologram layer or the application member.
- 2. (currently amended): A hologram transfer foil comprising a multilayer structure comprising, in order from top to bottom, a substrate, a surface protective layer, a volume hologram layer including a volume hologram in a cured resin layer and comprising a matrix polymer, a photopolymerizable compound and a photo-polymerization initiator, a first heat seal layer formed of a solution coating layer having an aqueous thermoplastic resin dissolved in water and a second heat seal layer which are successively stacked, wherein said substrate is releasable from the remainder of the multilayer structure, and wherein in use, said hologram transfer foil is applied on the second heat seal layer side over an application member, and an adhesion force of the volume hologram layer to the application member is larger than a material fracture force for the volume hologram layer or the application member.

- 3. (currently amended): The hologram transfer foil of claim 1 or 2, wherein in use, said hologram transfer foil is applied on the second heat seal layer side over an application member, and an adhesion force of the volume hologram layer to the application member is larger than a material fracture force for the volume hologram layer or the application member the first heat seal layer is a transparent heat seal layer and the second heat seal layer is a colored heat seal layer.
- 4. (currently amended): The hologram transfer foil of claim 3, wherein the first heat seal layer is a transparent, aqueous heat seal layer and the second heat seal layer is a colored heat seal layer colored heat seal layer is a multilayer structure comprising a colored layer and a transparent heat seal layer in order from the first heat seal layer.
- 5. (currently amended): The hologram transfer foil of claim 4, wherein the colored second heat seal layer is a multilayer structure comprising a colored layer and a transparent, second heat seal layer in order from the first heat seal layer is a colored layer-forming ink layer.
- 6. (currently amended): The hologram transfer foil of claim 5 claim 4, wherein the colored layer is a colored layer forming ink layer comprising a metal or a metal oxide.
- 7. (currently amended): The hologram transfer foil of elaim 1 or 2, wherein the colored layer is a layer comprising a metal or a metal oxide which further comprises a release sheet laminated on the surface of the second heat seal layer.
- 8. (currently amended): The hologram transfer foil of claim 1 or 2 3, which is laminated on further comprises a release sheet laminated on the surface of the second heat seal layer.

AMENDMENT

U.S. Appln. No. 09/843,891

9. (currently amended): The hologram transfer foil of claim 1 claim 4, wherein the

first heat seal layer is a colorless heat seal layer which further comprises a release sheet

laminated on the surface of the second heat seal layer.

10. (currently amended): The hologram transfer foil of claim 2 claim 5, wherein the

first heat seal layer is a colorless heat seal layer which further comprises a release sheet

laminated on the surface of the second heat seal layer.

11. (currently amended): [[A]] The hologram transfer foil comprising a multilayer

structure comprising, in order from top to bottom, a substrate, a volume hologram layer

including a volume hologram in a cured resin layer, first and second heat seal layers bonded

directly to each other, wherein said substrate is releasable from the remainder of the multilayer

structure of claim 6, which further comprises a release sheet laminated on the surface of the

second heat seal layer.

12-13. (canceled).

4